

Voidless Hermetically Sealed Surface Mount Bidirectional Transient Voltage Suppressors Data Sheet

1N6138AUS-1N6173AUS



Product Overview

This surface-mount series of industry-recognized voidless, hermetically sealed, bidirectional Transient Voltage Suppressor (TVS) designs are military qualified per MIL-PRF-19500/516 and are ideal for high-reliability applications where a failure cannot be tolerated. They provide a working peak “standoff” voltage selection from 5.2 V to 152 V with a 1500 W rating for a 10/1000 μ s pulse. They are very robust in hard-glass construction and use internal “Category 1” metallurgical bonds for high reliability. These are also available as both a non-suffix part and an “A” version part involving different voltage tolerances as further described in the [Part Nomenclature](#) section. These devices are also available in axial-leaded packages for through-hole mounting.

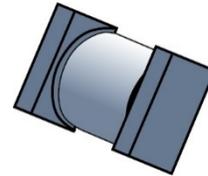
Features

- High surge current and peak pulse power provide transient voltage protection for sensitive circuits.
- Double-layer passivation
- Internal “Category 1” metallurgical bonds
- Voidless hermetically sealed glass package
- JAN, JANTX, JANTXV and JANS qualified versions are available per MIL-PRF-19500/516. (See [Part Nomenclature](#) for all available options).
- RoHS compliant versions available (commercial grade only)

Applications

- Military and other high-reliability applications
- Extremely robust construction
- Extensive range in working peak “standoff” voltage (V_{WM}) from 5.2 V to 152 V
- 1500 W peak pulse power (P_{PP}) for a 10/1000 μ s pulse
- ESD and EFT protection per IEC6100-4-2 and IEC61000-4-4 respectively
- Protection from the secondary effects of lightning per select levels in IEC61000-4-5
- Square-end-cap terminals for easy placement
- Non-sensitive to ESD per MIL-STD-750 method 1020
- Inherently radiation hard as described in [MicroNote 050](#).

Figure 1. “C” or SQ-MELF



1. Maximum Ratings

Maximum ratings are taken at $T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted.

| Parameters/Test Conditions | Symbol | Value | Unit |
|---|---------------------|-------------|---------------------------|
| Junction and storage temperature | T_J and T_{STG} | -55 to +175 | $^\circ\text{C}$ |
| Thermal resistance junction-to-end cap | $R_{\theta JEC}$ | 5.0 | $^\circ\text{C}/\text{W}$ |
| Peak pulse power at $25\text{ }^\circ\text{C}$ (10/1000 μs) | P_{PP} | 1500 | W |
| Off-state power up to $T_{EC} = 150\text{ }^\circ\text{C}^1$ | P_D | 5.0 | W |
| Off-state power at $T_A = 25\text{ }^\circ\text{C}^2$ | P_D | 3.0 | W |
| Impulse repetition rate | df | 0.01 | % |
| Solder temperature at 10 seconds | T_{SP} | 260 | $^\circ\text{C}$ |

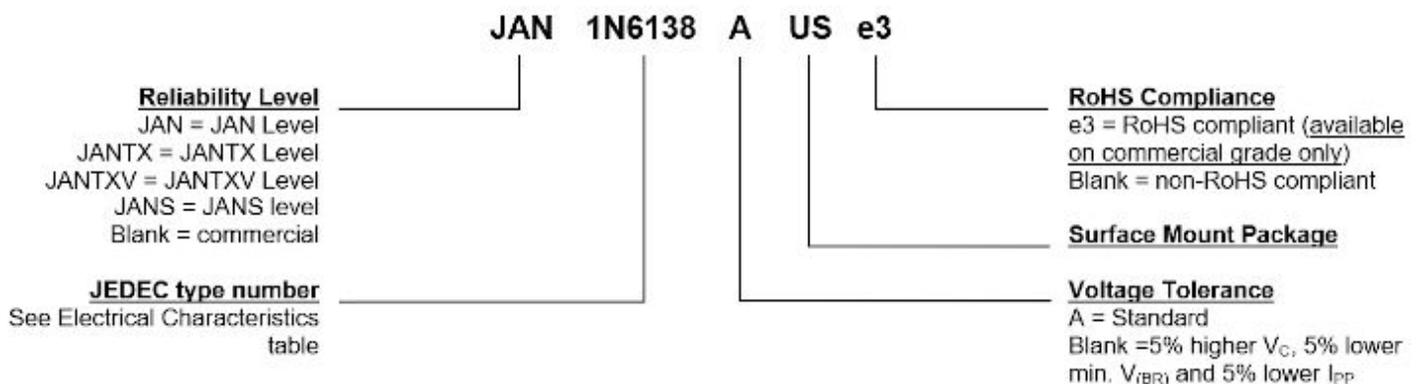
Notes:

1. Linearly derate above $T_{EC} = 150\text{ }^\circ\text{C}$ to zero at $T_{EC} = 175\text{ }^\circ\text{C}$.
2. Steady-state power ratings with reference to ambient are for PC boards where thermal resistance from mounting point to ambient is sufficiently controlled where T_{OP} or $T_{J(MAX)}$ is not exceeded (also see [Figure 3-5](#)).

1.1 Mechanical and Packaging

- Case: Hermetically sealed, voidless hard glass with tungsten slugs
- Terminals: Tin/lead plate over copper. RoHS compliant matte-tin is available on commercial grade only.
- Marking: None
- Polarity: No polarity marking for these bidirectional TVSs
- Tape and reel option: Standard per EIA-481-B. Consult factory for quantities.
- Weight: Approximately 1100 mg
- See [Package Dimensions](#).

1.2 Part Nomenclature



2. Symbols and Definitions

| Symbol | Definition |
|------------------|--|
| $\alpha_{V(BR)}$ | Temperature coefficient of minimum breakdown voltage: The change in breakdown voltage divided by the change in temperature that caused it expressed in %/°C or mV/°C. |
| $V_{(BR)}$ | Breakdown voltage: The voltage across the device at a specified current $I_{(BR)}$ in the breakdown region. |
| V_{WM} | Working standoff voltage: The maximum-rated value of dc or repetitive peak positive cathode-to-anode voltage that may be continuously applied over the standard operating temperature. |
| I_D | Standby current: The current through the device at rated stand-off voltage. |
| V_C | Clamping voltage: The voltage across the device in a region of low differential resistance during the application of an impulse current (I_{PP}) for a specified waveform. |
| P_{PP} | Peak pulse power. The rated random recurring peak impulse power or rated nonrepetitive peak impulse power. The impulse power is the maximum-rated value of the product of I_{PP} and V_C . |

2.1 Electrical Characteristics

| Industry Type Number ¹ | Minimum Breakdown Voltage ¹ $V_{(BR)}$ at $I_{(BR)}$ | | Rated Standoff Voltage V_{WM} | Maximum Standby Current I_D at V_{WM} | Maximum Clamping Voltage ¹ V_C at I_{PP} | Maximum Peak Pulse Current ¹ I_{PP} | Maximum Temp. Coef. of $V_{(BR)}$ $\alpha_{V(BR)}$ |
|-----------------------------------|--|-----|------------------------------------|--|--|---|--|
| | V | mA | V | μ A | V | A | %/°C |
| 1N6138AUS | 6.46 | 175 | 5.2 | 500 | 10.5 | 142.8 | 0.05 |
| 1N6139AUS | 7.13 | 175 | 5.7 | 300 | 11.2 | 133.9 | 0.06 |
| 1N6140AUS | 7.79 | 150 | 6.2 | 100 | 12.1 | 124.0 | 0.06 |
| 1N6141AUS | 8.65 | 150 | 6.9 | 100 | 13.4 | 111.9 | 0.06 |
| 1N6142AUS | 9.50 | 125 | 7.6 | 100 | 14.5 | 103.4 | 0.07 |
| 1N6143AUS | 10.45 | 125 | 8.4 | 20 | 15.6 | 96.2 | 0.07 |
| 1N6144AUS | 11.40 | 100 | 9.1 | 20 | 16.9 | 88.8 | 0.07 |
| 1N6145AUS | 12.35 | 100 | 9.9 | 20 | 18.2 | 82.4 | 0.08 |
| 1N6146AUS | 14.25 | 75 | 11.4 | 20 | 21.0 | 71.4 | 0.08 |
| 1N6147AUS | 15.20 | 75 | 12.2 | 20 | 22.3 | 67.3 | 0.08 |
| 1N6148AUS | 17.10 | 65 | 13.7 | 10 | 25.1 | 59.8 | 0.085 |
| 1N6149AUS | 19.0 | 65 | 15.2 | 5 | 27.7 | 54.2 | 0.085 |
| 1N6150AUS | 20.9 | 50 | 16.7 | 5 | 30.5 | 49.2 | 0.085 |
| 1N6151AUS | 22.8 | 50 | 18.2 | 5 | 33.3 | 45.0 | 0.09 |
| 1N6152AUS | 25.7 | 50 | 20.6 | 5 | 37.4 | 40.1 | 0.09 |
| 1N6153AUS | 28.5 | 40 | 22.8 | 5 | 41.6 | 36.0 | 0.09 |
| 1N6154AUS | 31.4 | 40 | 25.1 | 5 | 45.7 | 32.8 | 0.095 |
| 1N6155AUS | 34.2 | 30 | 27.4 | 5 | 49.9 | 30.1 | 0.095 |
| 1N6156AUS | 37.1 | 30 | 29.7 | 5 | 53.6 | 28.0 | 0.095 |
| 1N6157AUS | 40.9 | 30 | 32.7 | 5 | 59.1 | 25.4 | 0.095 |
| 1N6158AUS | 44.7 | 25 | 35.8 | 5 | 64.6 | 23.2 | 0.095 |
| 1N6159AUS | 48.5 | 25 | 38.8 | 5 | 70.1 | 21.4 | 0.095 |

.....continued

| Industry Type Number ¹ | Minimum Breakdown Voltage ¹ $V_{(BR)}$ at $I_{(BR)}$ | | Rated Standoff Voltage V_{WM} | Maximum Standby Current I_D at V_{WM} | Maximum Clamping Voltage ¹ V_C at I_{PP} | Maximum Peak Pulse Current ¹ I_{PP} | Maximum Temp. Coef. of $V_{(BR)}$ $\alpha_{V(BR)}$ |
|-----------------------------------|--|----|------------------------------------|--|--|---|--|
| | V | mA | V | μ A | V | A | %/°C |
| 1N6160AUS | 53.2 | 20 | 42.6 | 5 | 77.0 | 19.5 | 0.095 |
| 1N6161AUS | 58.9 | 20 | 47.1 | 5 | 85.3 | 17.6 | 0.100 |
| 1N6162AUS | 64.6 | 20 | 51.7 | 5 | 97.1 | 15.4 | 0.100 |
| 1N6163AUS | 71.3 | 20 | 56.0 | 5 | 103.1 | 14.5 | 0.100 |
| 1N6164AUS | 77.9 | 15 | 62.2 | 5 | 112.8 | 13.3 | 0.100 |
| 1N6165AUS | 86.5 | 15 | 69.2 | 5 | 125.1 | 12.0 | 0.100 |
| 1N6166AUS | 95.0 | 12 | 76.0 | 5 | 137.6 | 10.9 | 0.100 |
| 1N6167AUS | 104.5 | 12 | 86.6 | 5 | 151.3 | 9.9 | 0.100 |
| 1N6168AUS | 114.0 | 10 | 91.2 | 5 | 165.1 | 9.1 | 0.100 |
| 1N6169AUS | 123.5 | 10 | 98.8 | 5 | 178.8 | 8.4 | 0.105 |
| 1N6170AUS | 142.5 | 8 | 114.0 | 5 | 206.3 | 7.3 | 0.105 |
| 1N6171AUS | 152.0 | 8 | 121.6 | 5 | 218.4 | 6.9 | 0.105 |
| 1N6172AUS | 171.0 | 5 | 136.8 | 5 | 245.7 | 6.1 | 0.110 |
| 1N6173AUS | 190.0 | 5 | 152.0 | 5 | 273.0 | 5.5 | 0.110 |

Note:

1. Part number without the A suffix has 5% higher V_C , 5% lower minimum $V_{(BR)}$, and 5% lower I_{PP} .

3. Performance Curves

Figure 3-1. Peak Pulse Power vs. Pulse Time

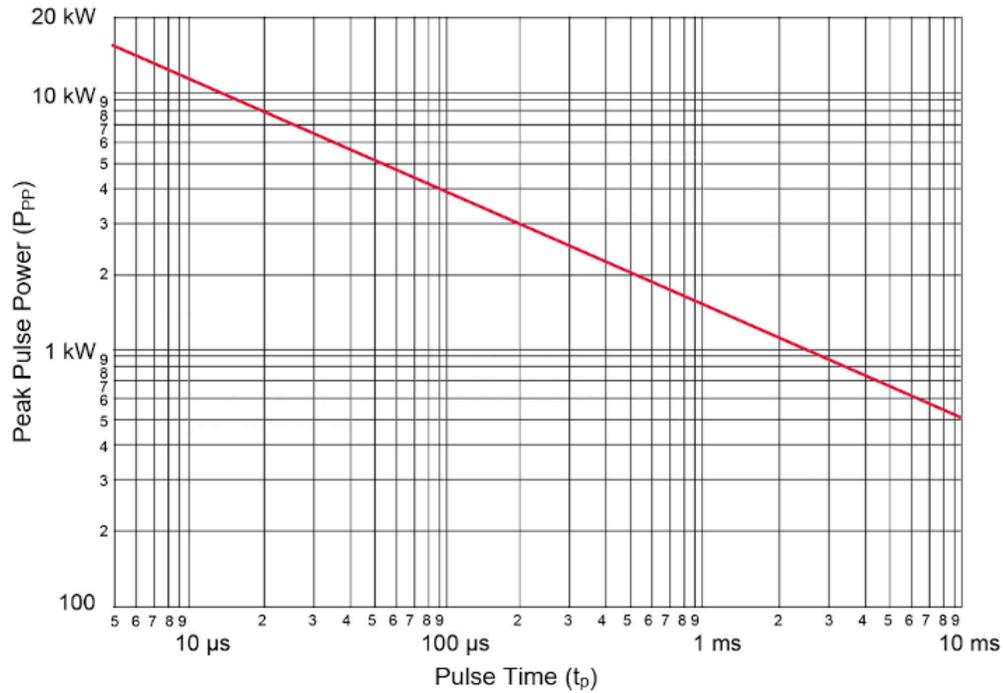


Figure 3-2. Pulse Derating Curve (Not Applicable to JANHC/JANKC Die)

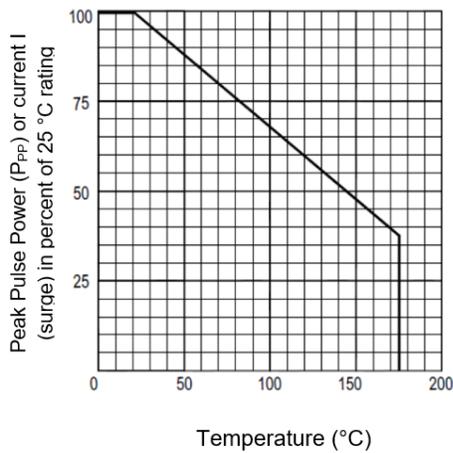


Figure 3-3. Pulse Waveform

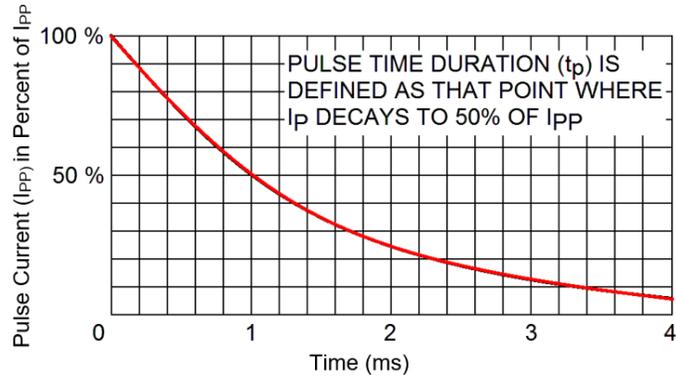


Figure 3-4. Temperature-Power Derating Curve

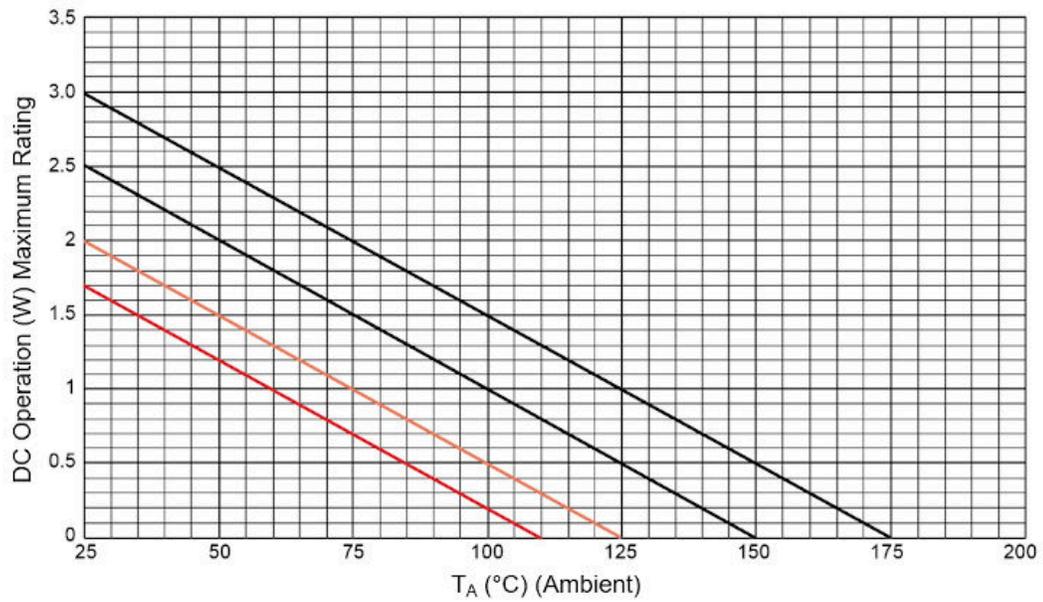
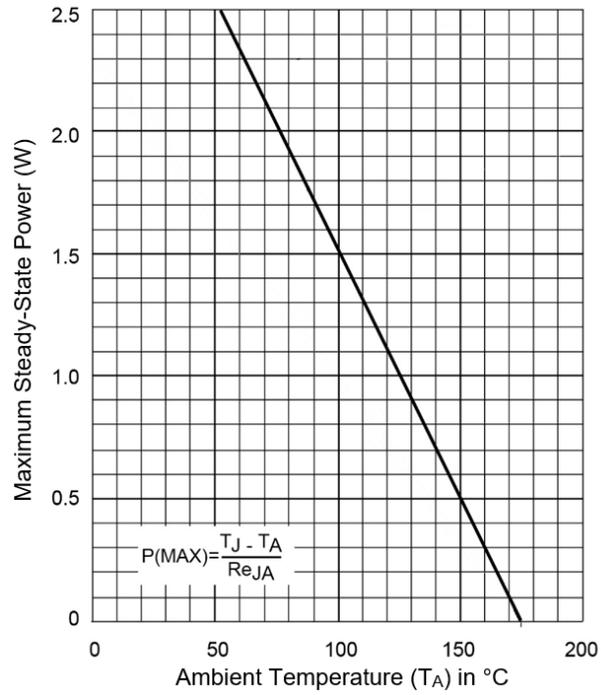
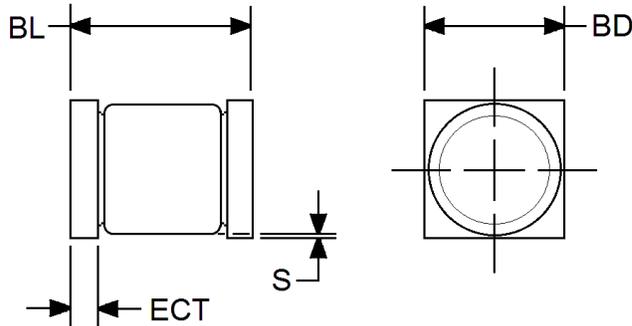


Figure 3-5. Steady-State Derating Curve for Free-Air Mounting ($R_{\theta JA} = 50\text{ }^{\circ}\text{C/W}$)



4. Package Dimensions

Dimensions are in inches. Millimeters are given for general information only. Minimum clearance of glass body to mounting surface on all orientations.

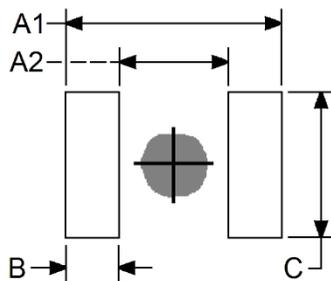


| Ltr | Inch | | Millimeters | | Notes |
|-----|-------|-------|-------------|------|-------|
| | Min | Max | Min | Max | |
| BD | 0.183 | 0.202 | 4.65 | 5.13 | |
| BL | 0.205 | 0.245 | 5.21 | 6.22 | |
| ECT | 0.019 | 0.028 | 0.48 | 0.71 | |
| S | 0.003 | - | 0.08 | - | 1 |

Note:

- In accordance with ASME Y14.5M, diameters are equivalent to Φ x symbology.

4.1 Pad Layout



| Dim | Inch | Millimeters |
|-----|-------|-------------|
| A1 | 0.310 | 7.87 |
| A2 | 0.170 | 4.32 |
| B | 0.070 | 1.78 |
| C | 0.205 | 5.21 |

If mounting requires adhesive separate from the solder, an additional 0.090 inch (2.29 mm) diameter contact may be placed in the center between the pads as an optional spot for cement.

5. Revision History

The revision history describes the changes that were implemented in the document. The changes are listed by revision, starting with the most current publication.

| Revision | Date | Description |
|----------|---------|---|
| A | 06/2023 | Converted document to Microchip template. |

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